

5-V Low Drop Fixed Voltage Regulator

TLE 4275



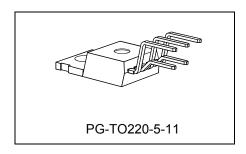


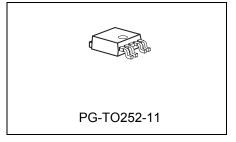
Features

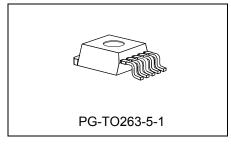
- Output voltage 5 V ± 2%
- Very low current consumption
- Power-on and undervoltage reset
- Reset low down to $V_{\rm O}$ = 1 V
- Very low-drop voltage
- Short-circuit-proof
- Reverse polarity proof
- Suitable for use in automotive electronics
- ESD protection > 4 kV
- Green Product (RoHS compliant) version of TLE 4275
- AEC qualified

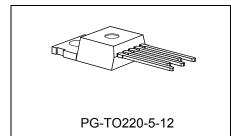


The TLE 4275 is a monolithic integrated low-drop voltage regulator in a 5-pin TO-package. An input voltage up to 45 V is regulated to $V_{\rm Q,nom}$ = 5.0 V. The IC is able to drive loads up to 450 mA and is short-circuit proof. At overtemperature the TLE 4275 is turned off by the incorporated temperature protection. A reset signal is generated for an output voltage $V_{\rm Q,rt}$ of typ. 4.65 V. The delay time can be programmed by the external delay capacitor.









Туре	Package
TLE 4275	PG-TO220-5-11 (RoHS compliant)
TLE 4275 D	PG-TO252-5-11 (RoHS compliant)
TLE 4275 G	PG-TO263-5-1 (RoHS compliant)
TLE 4275 S	PG-TO220-5-12 (RoHS compliant)



Dimensioning Information on External Components

The input capacitor $C_{\rm I}$ is necessary for compensation of line influences. Using a resistor of approx. 1 Ω in series with $C_{\rm I}$, the oscillating of input inductivity and input capacitance can be damped. The output capacitor $C_{\rm Q}$ is necessary for the stability of the regulation circuit. Stability is guaranteed at values $C_{\rm Q} \geq$ 22 $\mu \rm F$ and an ESR of \leq 5 Ω within the operating temperature range.

Circuit Description

The control amplifier compares a reference voltage to a voltage that is proportional to the output voltage and drives the base of the series transistor via a buffer. Saturation control as a function of the load current prevents any oversaturation of the power element. The IC also incorporates a number of internal circuits for protection against:

- Overload
- Overtemperature
- Reverse polarity



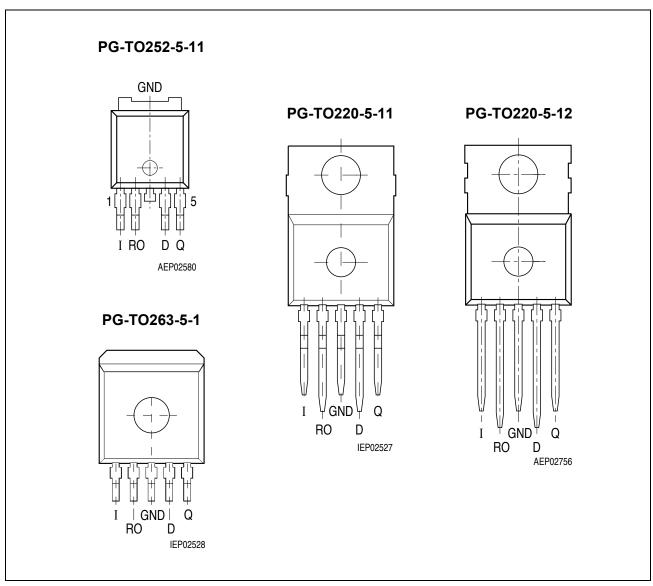


Figure 1 Pin Configuration (top view)

Table 1 Pin Definitions and Functions

Pin No.	Symbol	Function
1	I	Input; block to ground directly at the IC by a ceramic capacitor.
2	RO	Reset Output; open collector output
3	GND	Ground; Pin 3 internally connected to heatsink
4	D	Reset Delay; connect capacitor to GND for setting delay time
5	Q	Output; block to ground with a \ge 22 μF capacitor, ESR < 5 Ω at 10 kHz.

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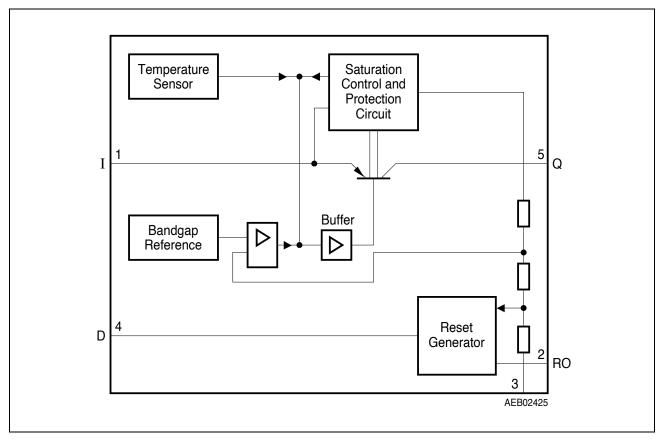


Figure 2 Block Diagram



Table 2 Absolute Maximum Ratings

Parameter	Symbol	Lim	it Values	Unit	Test Condition
		Min.	Max.		
Input					
Voltage	V_{l}	-42	45	V	_
Current	I_{l}	_	_	_	Internally limited
Output					
Voltage	V_{Q}	-1.0	16	V	_
Current	I_{Q}	_	_	_	Internally limited
Reset Output	·			·	
Voltage	V_{RO}	-0.3	25	V	_
Current	I_{RO}	- 5	5	mA	_
Reset Delay	·			·	
Voltage	V_{D}	-0.3	7	V	_
Current	I_{D}	-2	2	mA	_
Temperature					
Junction temperature	T_{j}	-40	150	°C	_
Storage temperature	T_{stg}	-50	150	°C	_

Note: Maximum ratings are absolute ratings; exceeding any one of these values may cause irreversible damage to the integrated circuit.

Table 3 Operating Range

Parameter	Symbol	Lim	it Values	Unit	Remarks
		Min.	Max.		
Input voltage	V_1	5.5	42	V	_
Junction temperature	$T_{\rm j}$	-40	150	°C	_
Thermal Resistance				•	•
Junction case	R_{thjc}	_	4	K/W	_
Junction ambient	$R_{\text{thj-a}}$	-	53	K/W	TO263 ¹⁾
Junction ambient	$R_{\text{thj-a}}$	-	78	K/W	TO252 ¹⁾
Junction ambient	R_{thi-a}	_	65	K/W	TO220

¹⁾ Worst case, regarding peak temperature; zero airflow; mounted on a PCB FR4, $80 \times 80 \times 1.5$ mm³, heat sink area 300 mm²



Table 4 Characteristics

 $V_{\rm I}$ = 13.5 V; -40 $^{\circ}{\rm C}$ < $T_{\rm j}$ < 150 $^{\circ}{\rm C}$ (unless otherwise specified)

Parameter	Symbol	Limit Values			Unit	Measuring
		Min.	Тур.	Max.	-	Condition
Output		ı	1		1	•
Output voltage	V_{Q}	4.9	5.0	5.1	V	$5 \text{ mA} < I_{\text{Q}} < 400 \text{ mA}$ $6 \text{ V} < V_{\text{I}} < 28 \text{ V}$
Output voltage	V_{Q}	4.9	5.0	5.1	V	$5 \text{ mA} < I_{\text{Q}} < 200 \text{ mA}$ $6 \text{ V} < V_{\text{I}} < 40 \text{ V}$
Output current limitation ¹⁾	I_{Q}	450	700	_	mA	_
Current consumption; $I_q = I_l - I_Q$	I_{q}	_	150	200	μΑ	$I_{\rm Q}$ = 1 mA; $T_{\rm j}$ = 25 °C
Current consumption; $I_{q} = I_{l} - I_{Q}$	I_{q}	_	150	220	μΑ	$I_{\rm Q}$ = 1 mA; $T_{\rm j}$ \leq 85 °C
Current consumption; $I_{q} = I_{l} - I_{Q}$	I_{q}	_	5	10	mA	$I_{\rm Q}$ = 250 mA
Current consumption; $I_{q} = I_{l} - I_{Q}$	I_{q}	_	12	22	mA	$I_{\rm Q}$ = 400 mA
Drop voltage ¹⁾	V_{dr}	_	250	500	mV	$I_{\rm Q}$ = 300 mA; $V_{\rm dr}$ = $V_{\rm I}$ - $V_{\rm Q}$
Load regulation	ΔV_{Q}	_	15	30	mV	$I_{\rm Q}$ = 5 mA to 400 mA
Line regulation	ΔV_{Q}	-15	5	15	mV	$\Delta V_{\rm I}$ = 8 V to 32 V $I_{\rm Q}$ = 5 mA
Power supply ripple rejection	PSRR	_	60	_	dB	$f_{\rm r}$ = 100 Hz; $V_{\rm r}$ = 0.5 Vpp
Temperature output voltage drift	dV_{Q}/dT	_	0.5	_	mV/K	_



Table 4Characteristics (cont'd)

 $V_{\rm I}$ = 13.5 V; -40 $^{\circ}{\rm C}$ < $T_{\rm j}$ < 150 $^{\circ}{\rm C}$ (unless otherwise specified)

Parameter	Symbol	Limit Values			Unit	Measuring	
		Min.	Тур.	Max.		Condition	
Reset Timing D and Output RO							
Reset switching threshold	$V_{Q,rt}$	4.5	4.65	4.8	V	_	
Reset output low voltage	V_{ROL}	_	0.2	0.4	V	$R_{\rm ext} \ge 5 \text{ k}\Omega;$ $V_{\rm Q} > 1 \text{ V}$	
Reset output leakage current	I_{ROH}	_	0	10	μΑ	V_{ROH} = 5 V	
Reset charging current	$I_{D,c}$	3.0	5.5	9.0	μΑ	<i>V</i> _D = 1 V	
Upper timing threshold	V_{DU}	1.5	1.8	2.2	V	_	
Lower timing threshold	V_{DRL}	0.2	0.4	0.7	V	_	
Reset delay time	$t_{\sf rd}$	10	16	22	ms	$C_{\rm D}$ = 47 nF	
Reset reaction time	t_{rr}	_	0.5	2	μs	$C_{\rm D}$ = 47 nF	

¹⁾ Measured when the output voltage $V_{\rm Q}$ has dropped 100 mV from the nominal value obtained at $V_{\rm I}$ = 13.5 V.

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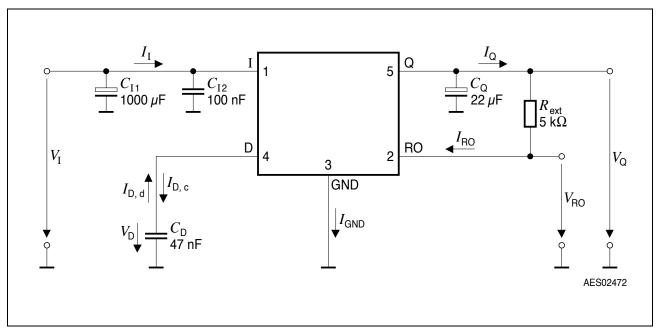


Figure 3 Test Circuit

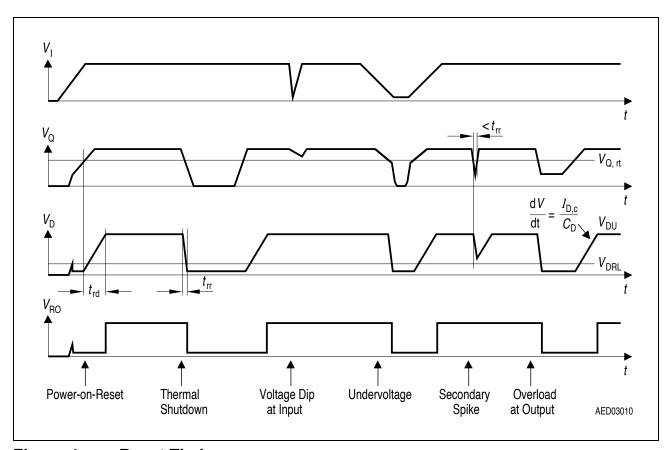
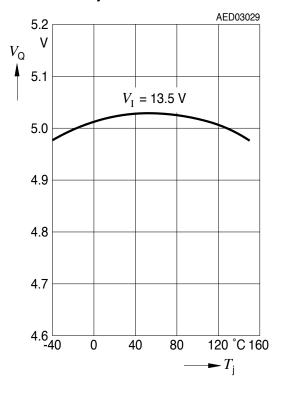


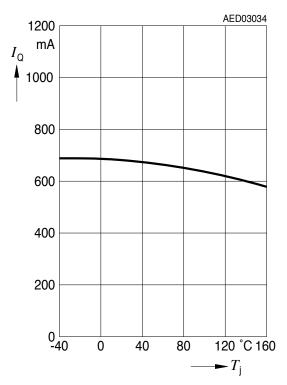
Figure 4 Reset Timing



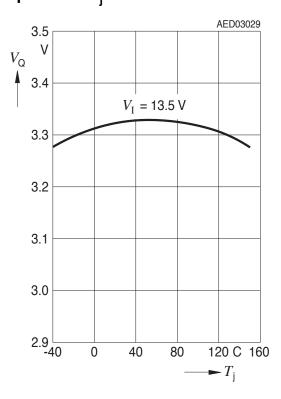
Output Voltage $V_{\rm Q}$ versus Temperature $T_{\rm j}$



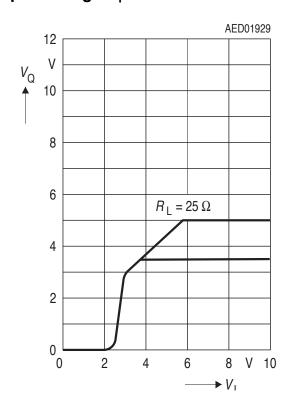
Output Current $I_{\rm Q}$ versus Temperature $T_{\rm j}$



Output Voltage $V_{\rm Q}$ versus Temperature $T_{\rm i}$

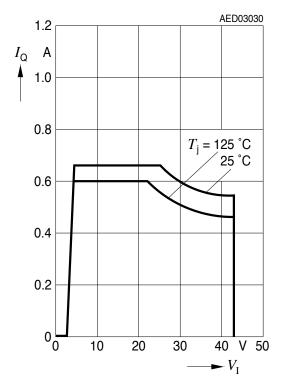


Output Voltage $V_{\rm Q}$ versus Input Voltage $V_{\rm I}$

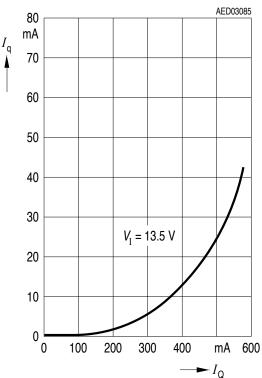




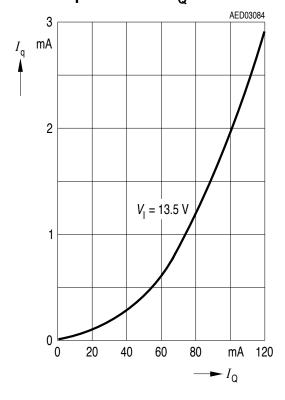
Output Current I_{Q} versus Input Voltage V_{I}



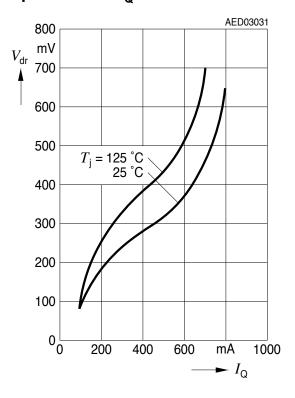
Current Consumption $I_{\rm q}$ versus Output Current $I_{\rm Q}$



Current Consumption $I_{\rm q}$ versus Output Current $I_{\rm O}$

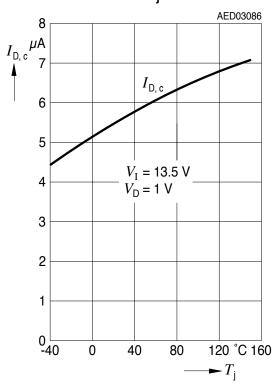


Drop Voltage $V_{ m dr}$ versus Output Current $I_{ m O}$

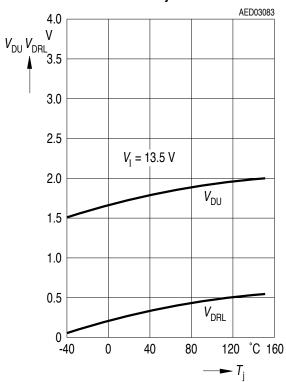




Charge Current $I_{\mathrm{D,c}}$ versus Temperature T_{i}



Delay Switching Threshold $V_{\mathrm{DU,}}$ V_{DRL} versus Temperature T_{j}





Package Outlines

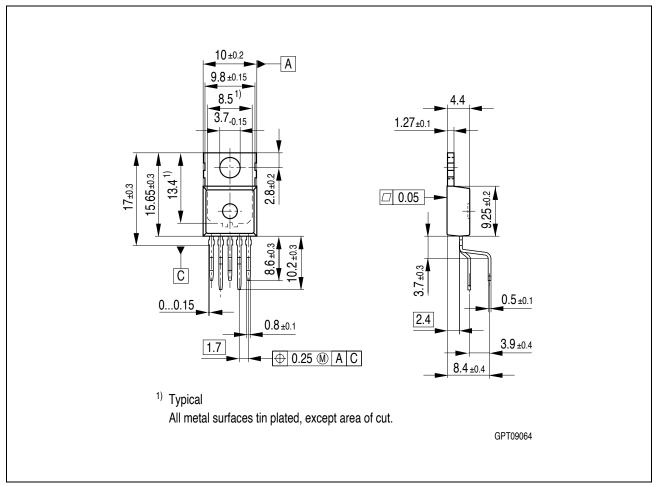


Figure 5 PG-TO220-5-11 (Plastic Transistor Single Outline)

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

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SMD = Surface Mounted Device



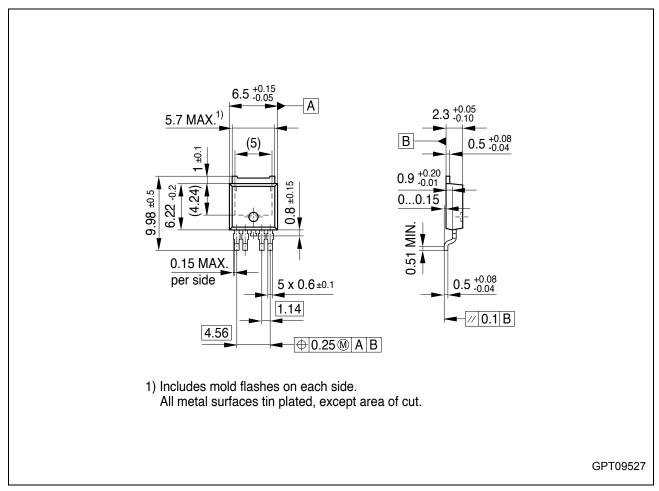


Figure 6 PG-TO252-5-11 (Plastic Transistor Single Outline)

Green Product (RoHS compliant)

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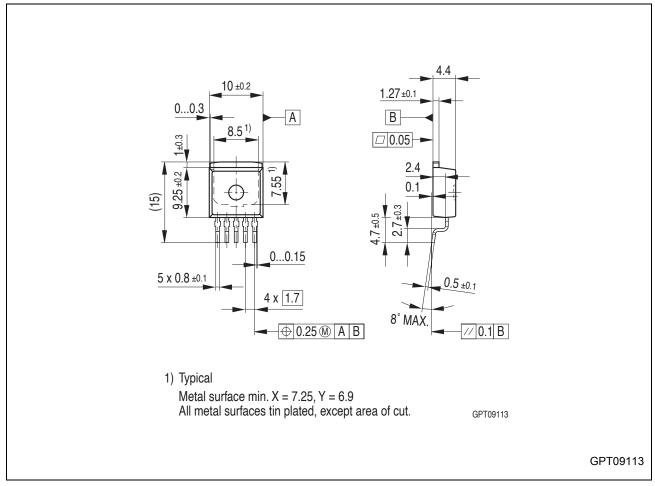


Figure 7 PG-TO263-5-1 (Plastic Transistor Single Outline)

Green Product (RoHS compliant)

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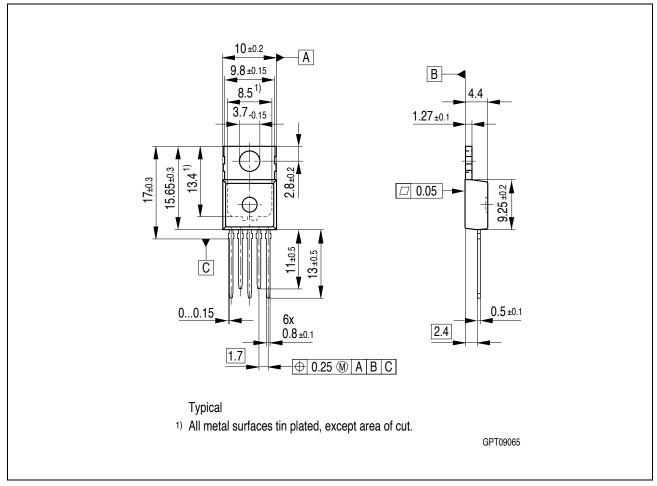


Figure 8 PG-TO220-5-12 (Plastic Transistor Single Outline)

Green Product (RoHS compliant)

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TLE 4275

Revision His	story: 2007-02-19	Rev. 1.7			
Previous Ver	sion: 1.6				
Page	Subjects (major changes since la	st revision)			
general	Removed all information related to to (See separate datasheet for the TL	•			
general	Updated Infineon logo				
#1	Added "AEC" and "Green" logo				
#1	Added "Green Product" and "AEC qualified" to the feature list				
#1	Updated Package Names to "PG-xxx"				
general	Removed leadframe variant "P-TO-252-1"				
#12 to #15	Added "Green Product" remark				
#17	Disclaimer Update				

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